

**ShenZhen BonFin Technology CO., ltd**  
*South floor 5, Xinlong Science and Technology Park, 2 Wangshan 1st Road, Shajing,  
Baoan District, Shenzhen, China*

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**Date: October 08, 2024**

**FCC ID: 2AWSC-A7**

**Model Number: A7, A9, H2, F18pro, U7, X1, X3, X5, X7, X10, X12, X18, F11, F12, F15, F16, F19, D10**

To: Federal Communication Commission  
Authorization and Evaluation Division 7435 Oakland Mills Road  
Columbia, MD 21048

To Whom It May Concern,

We, **ShenZhen BonFin Technology CO., ltd** hereby declare that our product (**Wireless headset**) Model Number: **A7, A9, H2, F18pro, U7, X1, X3, X5, X7, X10, X12, X18, F11, F12, F15, F16, F19, D10** board, Schematic, Hardware version, Software version, structure and internal photos are same, named and appearance differently due to marketing purposes.

Should you have any questions or comments regarding this matter, please have my best attention.

Sincerely,



(Signed)

Name / Title: Jason Zhou / Manager

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